504969104 06/20/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5015850

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KAI-YI HUANG	04/02/2018
SHENG-HUNG LIN	04/02/2018

RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORPORATION	
Street Address:	NO. 2, INNOVATION ROAD II, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	Taiwan ROC	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16013327

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	16313-139
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	06/20/2018

Total Attachments: 2

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PATENT 504969104 REEL: 046146 FRAME: 0575

ASSIGNMENT

WHEREAS, I(we), KAI-YI HUANG and SHENG-HUNG LIN whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled.

Integrated circuit structure, voltage-controlled oscillator and power amplifier

(hereinafter referred to as the INVENTION) for which an			tters Patent /Utility Patent
is executed on even date herewith unless at least one of	the following is	checked:	
United States Design Patent was			
D executed on:			
☐ filed on: Serial No.:			
🗖 established by PCT International Patent Applic	ation No.:	filed:	designating the
United States of America			
🗖 issued on as U.S. Patent	No.:		
WHEREAS, REALTEK SEMICONDUCTOR COR- Innovation Road II, Hsinchu Science Park, Hsinchu is desirous of acquiring the entire right, title and interes possessions;	300, Taiwan (R	.O.C.) hereinafte	er referred to as ASSIGNEE,
NOW, THEREFORE, for good and valuable consi ASSIGNOR, by these presents do sell, assign and transf and to said INVENTION and application throughout th Patent granted on any division, continuation, continuati terms for which the same may be granted, including all	er unto said ASS e United States on-in-part and re	IGNEE, the entire of America, incases in the of said app	e right, title, and interest in cluding any and all Letters plication for the full term or
ASSIGNOR further covenants that no assignments or entered into which would conflict with this Assignm		or encumbrance	e has been or will be made
ALSO, ASSIGNOR hereby agrees to execute any do- filing, prosecution and maintenance of said application said INVENTION, including additional documents that is said INVENTION, all without further consideration. A ASSIGNEE'S expense, to identify and communicate to A concerning the INVENTION that are within ASSIGNOR'S testimony on behalf of ASSIGNEE that lawfully may maintenance, litigation and defense of any patent ag- instrument. ASSIGNOR'S obligations under this in administrators and other legal representatives.	n or any other parmay be required ASSIGNOR also a ASSIGNEE at ASSI possession or cobe required of application or pate	atent application to affirm the rig grees, without fi GNEE'S request entrol, and to pro ASSIGNOR in recent encompasses	(s) in the United States for ghts of ASSIGNEE in and to jurther consideration and at documents and information vide further assurances and respect of the prosecution, d within the terms of this
ALSO, ASSIGNOR hereby authorizes and requests and all Letters Patent referred to above to ASSIGNEE, at the same, for ASSIGNEE'S sole use and behoof; and for successors, to the full end of the term for which such same would have been held by ASSIGNOR had this assist	s the ASSIGNEE of the use and beho Letters Patent m	of the entire right oof of ASSIGNEE hay be granted,	t, title and interest in and to 'S legal representatives and
ASSIGNOR NAME	Address		
KAI-YI HUANG	2F., No.23,	Sec. 2, Tongi 111, Taiwan (F	he E. St., Shilin Dist., R.O.C.)
Signature of Assignor	Date of Signatu	170	
Signature of Assignor Kair - Vi (Frang	April 2,		
The state of the s			
Name of Witness (optional)	Name of Witnes	s (opuonai)	

Signature of Witness (Optional)

Signature of Witness (optional)

PATENT REEL: 046146 FRAME: 0576

106A-038US(EN17RT018US)

ASSIGNOR NAME SHENG-HUNG LIN	Address 5F., No.9, Ln. 191, Yuxi St., Yonghe Dist., New Taipei City 234, Taiwan (R.O.C.)
Signature of Assignor Sheng - Hung Lin.	Date of Signature April 2, 2018
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 046146 FRAME: 0577

RECORDED: 06/20/2018